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Dated: August 12, 2008

Electronic Signature for Yung-Hoon Ha: /Yung-Hoon Ha/

Docket No.: 0042697.00149US3
(PATENT)

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant: Roy G. GORDON et al. Confirmation No.: 7410
Application No.: 10/534,687 Art Unit: 4172
Filed: May 12, 2005 Examiner: M. Wieczorek
Title: ATOMIC LAYER DEPOSITION USING METAL AMIDINATES

MS Amendment
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

AMENDMENT IN RESPONSE TO NON-FINAL OFFICE ACTION

Dear Sir:

INTRODUCTORY COMMENTS

In response to the Office Action dated June 9, 2008, please amend the above-identified U.S. patent application as follows:

Amendments to the Claims are reflected in the listing of claims which begins on page 2 of this paper.

Remarks/Arguments begin on page 6 of this paper.